### DATASHEET



# QBVK037A5S9R6 Barracuda\* Series; DC-DC Converter Power Modules

38-55V<sub>dc</sub> Input; 9.6V<sub>dc</sub>, 37.5A, 360W Output

# RoHS Compliant

### **Description**

The QBVK037A5S9R6 Barracuda series of dc-dc converters are a new generation of fully regulated DC/DC power modules designed to support 9.6V<sub>dc</sub> intermediate bus applications where multiple low voltages are subsequently generated using point of load (POL) converters, as well as other application requiring a tightly regulated output voltage. The QBVK037A5S9R6 series operate from an input voltage range of 38 to 55V<sub>dc</sub> and

provide up to 37.5A output current at output voltages of  $9.6V_{dc}$  in an industry standard, DOSA compliant quarter brick. The converter incorporates digital control, synchronous rectification technology, a fully regulated control topology, and innovative packaging techniques to achieve efficiency exceeding 95.8% at 9.6V output. This leads to lower power dissipations such that for many applications a heat sink is not required. Standard features include on/off control, output overcurrent and over voltage protection, over temperature protection, input under and over voltage lockout.

The output is fully isolated from the input, allowing versatile polarity configurations and grounding connections. Built-in filtering for both input and output minimizes the need for external filtering.

### **Applications**

- Distributed power architectures
- Intermediate bus voltage applications
- Servers and storage applications
- Fan assemblies and other systems requiring a tightly regulated output voltage



### **Features**

- Compliant to RoHS Directive 2011/65/EU and amended Directive (EU) 2015/863 (-Z versions)
- Compliant to REACH Directive (EC) No 1907/2006
   Can be processed with paste-through-hole Pb or Pb
  -free reflow process
- High full load efficiency >95.8% at V<sub>in</sub>=48V<sub>dc</sub>
- Input voltage range: 38-55V<sub>dc</sub>
- Delivers up to 37.5A<sub>dc</sub> output current
- Fully very tightly regulated output voltage
- Low output ripple and noise
- Industry standard, DOSA Compliant Quarter Brick: 58.4 mm x 36.8 mm x 12.2 mm MAX (2.30 in x 1.45 in x 0.48 in, MAX)
- Constant switching frequency
- Positive Remote On/Off logic
- Output over current/voltage protection
- Over temperature protection

- Wide operating temperature range
   -5°C to 55°C, continuous, 100% load, ≥ 1.0m/s
   [200LFM] -20°C to 70°C, short term, ≤ 96hrs/year,
   100% load -5°C to 85°C, continuous, derated load
- ANSI/UL\* 62368-1 and CAN/CSA† C22.2 No. 62368-1 Recognized, DIN VDE‡ 0868-1/A11:2017 (EN62368- 1:2014/A11:2017)
- CE mark to 2014/35/EU directive<sup>§</sup>
- 750Vdc Functional Isolation
- ISO\*\* 9001 and ISO14001 certified manufacturing facilities
- Negative Remote On/Off logic (1=option code, factory preferred)
- Passive Droop Load Sharing (-P=option code)
- Base Plate (-H=option code)
- Auto-restart after fault shutdown (4=option code, factory preferred)

### FOOTNOTE

<sup>\*</sup> Trademark of OmniOn Company

<sup>#</sup> UL is a registered trademark of Underwriters Laboratories, Inc.

<sup>†</sup> CSA is a registered trademark of Canadian Standards Association.

<sup>‡</sup> VDE is a trademark of Verband Deutscher Elektrotechniker e.V.

<sup>§</sup> This product is intended for integration into end-user equipment . All of the required procedures of end-use equipment should be followed.

<sup>\*\*</sup> ISO is a registered trademark of the International Organization of Standards.



# **Technical Specifications**

### **Absolute Maximum Ratings**

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the Data Sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Parameter	Device	Symbol	Min	Max	Unit
Input Voltage*					
Continuous		$V_{IN}$	0.3	55	$V_{dc}$
Non-operating continuous		$V_{IN}$	0.9	64	$V_{dc}$
Continuous Operating Ambient Temperature, 100% Load, Airflow ≥ 1.0m/s [200LFM], V <sub>IN</sub> = 38 to 55V		T <sub>A</sub>	-5	55	°C
Short term Operating Ambient Temperature, 100% Load, ≤ 96hrs/year; Airflow ≥ 1.0m/s [200LFM], V <sub>IN</sub> = 38 to 55V	All	T <sub>A</sub>	-20	70	°C
Continuous Derated Operating Ambient Temperature (See Thermal Considerations section)		T <sub>A</sub>		85	°C
Storage Temperature	All	T <sub>stg</sub>	-40	125	°C
I/O Isolation Voltage (100% factory Hi-Pot tested)	All	_		750	V

Input over voltage protection will shutdown the output voltage when the input voltage exceeds threshold level.

### **Electrical Specifications**

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

Parameter	Device	Symbol	Min	Тур	Max	Unit
Operating Input Voltage		V <sub>IN</sub>	38	42/50	55	$V_{dc}$
Maximum Input Current $(V_{IN}=38V, I_O=I_{O, max})$		I <sub>IN,max</sub>	_	_	10	$A_{dc}$
Input No Load Current $(V_{IN} = V_{IN, nom}, I_O = 0, module enabled)$	All	I <sub>IN</sub> ,No load		130		mA
Input Stand-by Current $(V_{IN} = V_{IN, nom}, module disabled)$	All	I <sub>IN</sub> ,stand-by			35	mA
External Input Capacitance	All		100	_	360	μF
Inrush Transient	All	l²t	_	_	1	$A^2s$
Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, 12 $\mu$ H source impedance; $V_{IN}$ = 48V, $I_{O}$ = $I_{Omax}$ ; see Figure 9)	All		_	35		mA <sub>p-p</sub>
Input Terminal Ripple Current (Measured at module input pin with maximum specified input capacitance and < 500uH inductance between voltage source and input capacitance) 5Hz to 20MHz, V <sub>IN</sub> = 38V to 55V, I <sub>O</sub> = I <sub>Omax</sub>	All		_	_	360	mA <sub>rms</sub>
Input Ripple Rejection (120Hz)	All			20	_	dB

### CAUTION: This power module is not internally fused. An input line fuse must always be used.

This power module can be used in a wide variety of applications, ranging from simple standalone operation to an integrated part of sophisticated power architecture. To preserve maximum flexibility, internal fusing is not included, however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a fast-acting fuse with a maximum rating of 15A in the ungrounded input lead of the power supply (see Safety Considerations section). Based on the information provided in this Data Sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's Data Sheet for further information.



# **Electrical Specifications** (continued)

Parameter	Device	Symbol	Min	Тур	Max	Unit
Output Voltage Set-point ( $V_{IN}=V_{IN,nom}$ , $I_0=18.8A$ , $T_A=25^{\circ}C$ )	All	$V_{\text{O, set}}$	9.55	9.60	9.65	$V_{dc}$
Output Voltage (Over all operating input voltage (38V to 55V), resistive load, and temperature conditions until end of life)	-P Option	Vo	8.90	-	10.30	Vdc
Output Regulation Line ( $V_{IN}$ = 40V to $V_{IN}$ , max) Load ( $I_{O}$ = $I_{O, min}$ to $I_{O, max}$ ), Intentional Droop Temperature ( $T_{A}$ = -5°C to +85°C)	All -P Option All		- -	0.3 0.20 -	- 0.02	% V <sub>O</sub> , set V <sub>dc</sub> %/°C
Output Ripple and Noise on nominal output (V <sub>IN</sub> =V <sub>IN</sub> , nom and I <sub>O</sub> =I <sub>O</sub> , min to I <sub>O, max</sub> ) C <sub>O</sub> =750uF RMS (5Hz to 20MHz bandwidth) Peak-to-Peak (5Hz to 20MHz bandwidth)	All All		-	70 -	- 150	mV <sub>rms</sub> mV <sub>pk-pk</sub>
External Output Capacitance For $C_0 > 4,500$ uF, $I_0$ must be < 35% $I_0$ , max during $T_{rise}$ . When 2 or more modules are in parallel	All -P Option	Co, max	0 0	-	4,500 9,000	μF μF
Output Current	All	lo	0	-	37.5	A <sub>dc</sub>
Output Current Limit Inception	All	$I_{O,lim}$	41.25	-	52.5	Adc
Output Power	All	Po	0	-	360	W
Efficiency V <sub>IN</sub> =V <sub>IN, nom</sub> , T <sub>A</sub> =25°C I <sub>O</sub> =100% I <sub>O, max</sub> , V <sub>O</sub> = V <sub>O,set</sub> I <sub>O</sub> =50% I <sub>O</sub> , max to 100% I <sub>O, max</sub> , V <sub>O</sub> = V <sub>O,set</sub>	All All	η η		95.8 95.0		% %
Switching Frequency (Primary FETs)		f <sub>sw</sub>		150		kHz
Dynamic Load Response  dIO/dt=1A/1ms; V <sub>in</sub> =V <sub>in,nom</sub> ; T <sub>A</sub> =25°C;  (Tested with a 1.0µF ceramic, and 1440µF capacitor and across the load.)						
Load Change from $I_{\rm O}$ = 50% to 75% of $I_{\rm O,max}$ : Peak Deviation Settling Time ( $V_{\rm O}$ <10% peak deviation)	All	$\begin{matrix} V_{pk} \\ t_s \end{matrix}$	- -	350 700	-	mV <sub>pk</sub>
Load Change from $I_0$ = 75% to 50% of $I_{O,max}$ : Peak Deviation Settling Time ( $V_0$ <10% peak deviation)	All	V <sub>pk</sub> t <sub>s</sub>	- -	350 700	- -	mV <sub>pk</sub> ms

# **Isolation Specifications**

Parameter	Symbol	Min	Тур	Max	Unit
Isolation Capacitance	C <sub>iso</sub>	_	0.01	_	μF
Isolation Resistance	R <sub>iso</sub>	10		_	МΩ

# **General Specifications**

Parameter	Device	Symbol	Тур	Unit
Calculated Reliability Based upon 480W parent product [QBVS044A4S10R8] and Telcordia SR-332 Issue	All	MTBF	3,570,960	Hours
2: Method I, Case 3, ( $I_0$ =80% $I_{0, max}$ , $T_A$ =40°C, Airflow = 200 LFM), 90% confidence		FIT	280.0	109/Hours
Weight– with Base Plate option			60.7 (2.14)	g (oz.)



# **Feature Specifications**

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

Parameter	Device	Symbol	Min	Тур	Max	Unit
Remote On/Off Signal Interface						
$(V_{IN}=V_{IN}, min to V_{IN, max}, Signal referenced to V_{IN}- terminal)$						
Negative Logic: device code suffix "1"						
Logic Low = module On, Logic High = module Off						
Positive Logic: No device code suffix required Logic Low = module Off, Logic High = module On						
Logic Low Specification						
On/Off Thresholds:						
Remote On/Off Current – Logic Low (V <sub>in</sub> =55V)	All	I <sub>on/off</sub>	-	-	200	μΑ
Logic Low Voltage	All	$V_{\text{on/off}}$	-0.3	-	0.8	$V_{dc}$
Logic High Voltage – (Typ = Open Collector)	All	$V_{\text{on/off}}$	2.4	-	14.5	$V_{dc}$
Logic High maximum allowable leakage current ( $V_{on/off}$ = 2.4V)	All	I <sub>on/off</sub>	-	-	130	μA
Maximum voltage allowed on On/Off pin	All	V <sub>on/off</sub>	-	-	14.5	$V_{dc}$
Turn-On Delay and Rise Times (I <sub>O</sub> =I <sub>O, max</sub> )						
$T_{delay}$ =Time until $V_O$ = 10% of $V_O$ ,set from either application of $V_{in}$ with Remote On/Off set to On (Enable with Vin); or operation of	All w/"P" option	T <sub>delay</sub> , Enable with Vin	-	-	15*	ms
Remote On/Off from Off to On with Vin already applied for at least 30 milli- seconds (Enable with on/off). *If pre-bias is detected, Tdelay will increase by an additional 5ms	All w/"P" option	T <sub>delay, Enable</sub> with on/off	-	-	10*	ms
$T_{rise}$ =Time for $V_O$ to rise from 10% to 90% of $V_{O,set}$ , For $C_O$ >4,500uF, $I_O$ must be < 35% $I_{O,max}$ during $T_{rise}$ .	All w/ "P" option	$T_{rise}$	-	-	15	ms
Output Overvoltage Protection	All	$V_{O,limit}$	12.0		14.0	$V_{dc}$
Maximum Long Term Reference Temperature	All	$T_{ref}$	_	110	_	°C
(See Feature Descriptions and Figure 13)	All	I ref		110	-	C
Input Undervoltage Lockout						
Turn-on Threshold			36	-	38	$V_{dc}$
Turn-off Threshold			33	-	36	$V_{dc}$
Hysteresis			2	-	-	$V_{dc}$
Input Overvoltage Lockout						
Turn-off Threshold			-	62	-	$V_{dc}$
Turn-on Threshold			-	60	-	$V_{dc}$



# Characteristic Curves, 9.6V<sub>dc</sub> Output

The following figures provide typical characteristics for the QBVK037A5S9R6 (9.6V, 37.5A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.

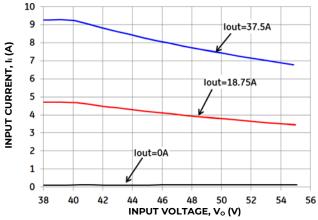


Figure 1. Typical Input Characteristic.

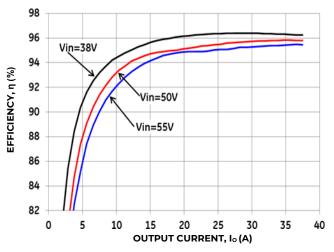


Figure 2. Typical Converter Efficiency vs. Output Current.

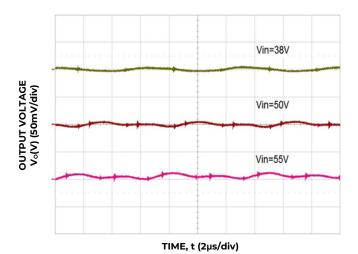


Figure 3. Typical Output Ripple and Noise,  $I_o$  =  $I_{o,max}$   $C_o$ =750 $\mu$ F.

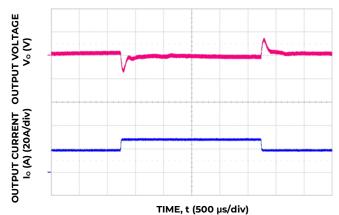


Figure 4. Typical Transient Response to 1A/ $\mu$ s Step Change in Load from 50% to 75% to 50% of Full Load, Co=1440 $\mu$ F and 50  $V_{dc}$  Input

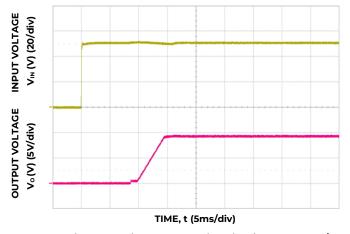


Figure 5. Typical Start-Up Using Vin with Remote On/Off enabled, negative logic version shown, I<sub>o</sub> = I<sub>o,max</sub>.

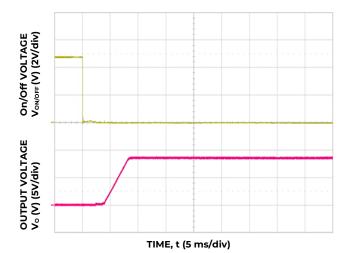


Figure 6. Typical Start-Up Using Remote On/Off with Vin applied, negative logic version shown  $I_0 = I_{0,max}$ .



# Characteristic Curves, 9.6V<sub>dc</sub> Output (continued)

The following figures provide typical characteristics for the QBVK037A5S9R6 (9.6V, 37.5A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.

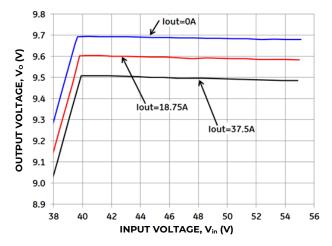


Figure 7. Typical Output Voltage Regulation vs. Input Voltage for the -P Version.

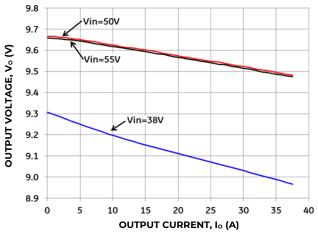
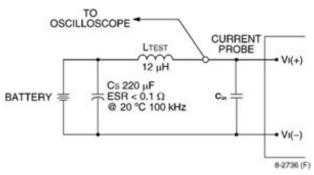


Figure 8. Typical Output Voltage Regulation vs. Output Current for the –P Version.

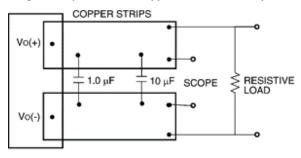


### **Test Configurations**



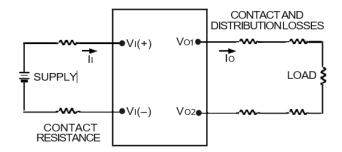
Note: Measure input reflected-ripple current with a simulated source inductance (LTEST) of 12 µH. Capacitor Cs offsets possible battery impedance. Measure current as shown above.

Figure 9. Input Reflected Ripple Current Test Setup.



Note: Use a 1.0 µF ceramic capacitor, a 10 µF aluminum or tantalum capacitor and a 750 polymer capacitor. Scope measurement should be made using a BNC socket. Position the load between 51 mm and 76 mm (2 in. and 3 in.) from the module.

Figure 10. Output Ripple and Noise Test Setup



Note: All measurements are taken at the module terminals. When socketing, place Kelvin connections at module terminals to avoid measurement errors due to socket contact resistance.

$$\eta = \left(\frac{[V_0(+) - V_0(-)]}{[V_i(+) - V_i(-)]I_i}\right) \times 100$$

Figure 11. Output Voltage and Efficiency Test Setup.

### **Design Considerations**

Input Source Impedance

The power module should be connected to a low acimpedance source. Highly inductive source impedance can affect the stability of the power module. For the test configuration in Figure 9, a 360µF electrolytic capacitor,  $C_{in}$ , (ESR<0.7 $\Omega$  at 100kHz), mounted close to the power module helps ensure the stability of the unit.

### Safety Considerations

For safety agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards, i.e., UL ANSI/UL\* 62368-1 and CAN/CSA+ C22.2 No. 62368-1 Recognized, DIN VDE 0868-1/A11:2017 (EN62368-1:2014/A11:2017)

If the input source is non-SELV (ELV or a hazardous voltage greater than 60 V<sub>dc</sub> and less than or equal to 75V<sub>dc</sub>), for the module's output to be considered as meeting the requirements for safety extra-low voltage (SELV) or ES1, all of the following must be true:

- The input source is to be provided with reinforced insulation from any other hazardous voltages, including the ac mains.
- One  $V_{IN}$  pin and one  $V_{OUT}$  pin are to be grounded, or both the input and output pins are to be kept floating.
- The input pins of the module are not operator accessible.
- Another SELV or ES1 reliability test is conducted on the whole system (combination of supply source and subject module), as required by the safety agencies, to verify that under a single fault, hazardous voltages do not appear at the module's output.

**Note:** Do not ground either of the input pins of the module without grounding one of the output pins. This may allow a non-SELV/ES1 voltage to appear between the output pins and ground.

The power module has safety extra-low voltage (SELV) or ES1 outputs when all inputs are SELV or ES1.

The input to these units is to be provided with a maximum 15 A fast-acting (or time-delay) fuse in the ungrounded input lead.



### **Feature Descriptions**

### **Overcurrent Protection**

To provide protection in a fault output overload condition, the module is equipped with internal current-limiting circuitry and can endure current limiting continuously. If the overcurrent condition causes the output voltage to fall greater than 3.5V from  $V_{o,set}$ , the module will shut down and remain latched off. The overcurrent latch is reset by either cycling the input power or by toggling the on/off pin for one second. If the output overload condition still exists when the module restarts, it will shut down again. This operation will continue indefinitely until the overcurrent condition is corrected.

A factory configured auto-restart option (with overcurrent and overvoltage auto-restart managed as a group) is also available. An auto-restart feature continually attempts to restore the operation until fault condition is cleared.

### Remote On/Off

The module contains a standard on/off control circuit reference to the V<sub>IN</sub>(-) terminal. Two factory configured remote on/off logic options are available. Positive logic remote on/off turns the module on during a logic-high voltage on the ON/OFF pin, and off during a logic low. Negative logic remote on/off turns the module off during a logic high, and on during a logic low. Negative logic, device code suffix "1," is the factorypreferred configuration. The On/Off circuit is powered from an internal bias supply, derived from the input voltage terminals. To turn the power module on and off, the user must supply a switch to control the voltage between the On/Off terminal and the  $V_{IN}(-)$ terminal (V<sub>on/off</sub>). The switch can be an open collector or equivalent (see Figure 12). A logic low is  $V_{on/off} = -0.3V$  to 0.8V. The typical  $I_{\text{on/off}}$  during a logic low ( $V_{\text{in}}$ =48V, On/ Off Terminal=0.3V) is 147µA. The switch should maintain a logic-low voltage while sinking 200µA. During a logic high, the maximum V<sub>on/off</sub> generated by the power module is 14.5V. The maximum allowable leakage current of the switch at  $V_{on/off}$  = 2.4V is 130 $\mu$ A. If using an external voltage source, the maximum voltage  $V_{\text{on/off}}$  on the pin is 14.5V with respect to the  $V_{\text{IN}}$ (-) terminal.

If not using the remote on/off feature, perform one of the following to turn the unit on:

For negative logic, short ON/OFF pin to  $V_{IN}(-)$ . For positive logic: leave ON/OFF pin open.

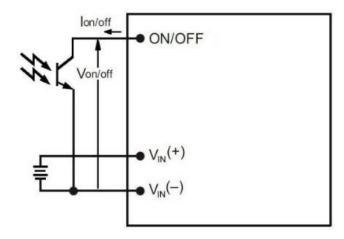


Figure 12. Remote On/Off Implementation.

### **Output Overvoltage Protection**

The module contains circuitry to detect and respond to output overvoltage conditions. If the overvoltage condition causes the output voltage to rise above the limit in the Specifications Table, the module will shut down and remain latched off. The overvoltage latch is reset by either cycling the input power, or by toggling the on/off pin for one second. If the output overvoltage condition still exists when the module restarts, it will shut down again. This operation will continue indefinitely until the overvoltage condition is corrected.

A factory configured auto-restart option (with overcurrent and overvoltage auto-restart managed as a group) is also available. An auto-restart feature continually attempts to restore the operation until fault condition is cleared.

### **Overtemperature Protection**

These modules feature an overtemperature protection circuit to safeguard against thermal damage. The circuit shuts down the module when the maximum device reference temperature is exceeded. The module will automatically restart once the reference temperature cools by ~25°C.

### Input Under/Over voltage Lockout

At input voltages above or below the input under/over voltage lockout limits, module operation is disabled. The module will begin to operate when the input voltage level changes to within the under and overvoltage lockout limits.



### Feature Descriptions (continued)

### **Load Sharing**

For higher power requirements, the QBVK037A5S9R6 power module offers an optional feature for parallel operation (-P Option code). This feature provides a precise forced output voltage load regulation droop characteristic. The output set point and droop slope are factory calibrated to insure optimum matching of multiple modules' load regulation characteristics. To implement load sharing, the following requirements should be followed:

- The V<sub>OUT</sub>(+) and V<sub>OUT</sub>(-) pins of all parallel modules must be connected together. Balance the trace resistance for each module's path to the output power planes, to insure best load sharing and operating temperature balance.
- $V_{IN}$  must remain between  $40V_{dc}$  and  $55V_{dc}$  for droop sharing to be functional.
- It is permissible to use a common Remote On/Off signal to start all modules in parallel.
- These modules contain means to block reverse current flow upon start-up, when output voltage is present from other parallel modules, thus eliminating the requirement for external output ORing devices. Modules with the –P option may automatically increase the Turn On delay, T<sub>delay</sub>, as specified in the Feature Specifications Table, if output voltage is present on the output bus at startup.
- When parallel modules startup into a pre-biased output, e.g. partially discharged output capacitance, the T<sub>rise</sub> is automatically increased, as specified in the Feature Specifications Table, to insure graceful startup.
- Insure that the total load is <50% I<sub>O,MAX</sub> (for a single module) until all parallel modules have started (load full start > module Tdelay time max + T<sub>rise</sub> time).
- If fault tolerance is desired in parallel applications, output ORing devices should be used to prevent a single module failure from collapsing the load bus.

### **Thermal Considerations**

The power modules operate in a variety of thermal environments and sufficient cooling should be provided to help ensure reliable operation.

Thermal considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel.

Heat-dissipating components are mounted on the top side of the module. Heat is removed by conduction, convection and radiation to the surrounding environment. Proper cooling can be verified by measuring the thermal reference temperature (T<sub>ref</sub>).

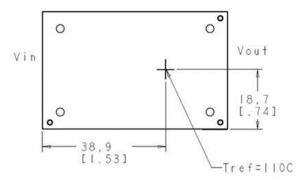


Figure 13. Location of the thermal reference temperature Tref.

Peak temperature occurs at the position indicated in Figure 13. For reliable operation this temperature should not exceed  $T_{\rm ref}$ =110°C. For extremely high reliability you can limit this temperature to a lower value. The output power of the module should not exceed the rated power for the module as listed in the Ordering Information table.

### **Heat Transfer via Convection**

The thermal data presented here is based on physical measurements taken in a wind tunnel, using automated thermo-couple instrumentation to monitor key component temperatures: FETs, diodes, control ICs, magnetic cores, ceramic capacitors, optoisolators, and module pwb conductors, while controlling the ambient airflow rate and temperature. For a given airflow and ambient temperature, the module output power is increased, until one (or more) of the components reaches its maximum derated operating temperature, as defined in IPC-9592B. This procedure is then repeated for a different airflow or ambient temperature until a family of module output derating curves is obtained. Please refer to the Application Note "Thermal Characterization Process For Open-Frame Board-Mounted Power Modules" for a detailed discussion of thermal aspects including maximum device temperatures.



### Feature Descriptions (continued)

### **Heat Transfer via Convection (continued)**

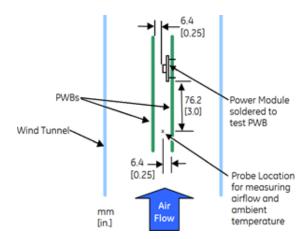


Figure 14. Thermal Test Setup

Increased airflow over the module enhances the heat transfer via convection. The thermal derating of figure 15- 20 shows the maximum output current that can be delivered by each module in the indicated orientation without exceeding the maximum  $T_{\text{ref}}$  temperature versus local ambient temperature (TA) for several air flow conditions.



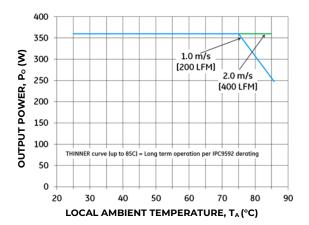


Figure 15. Output Power Derating for the QBVK037A5S9R6-H Base Plate Option in the Transverse Orientation; Airflow Direction from V<sub>in</sub>(-) to V<sub>in</sub>(+); V<sub>in</sub> = 38 to 42V.

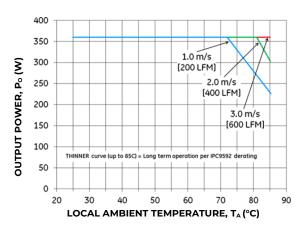


Figure 16. Output Power Derating for the QBVK037A5S9R6-H Base Plate Option in the Transverse Orientation; Airflow Direction from  $V_{in}(-)$  to  $V_{in}(+)$ ;  $V_{in} = 50V$ .

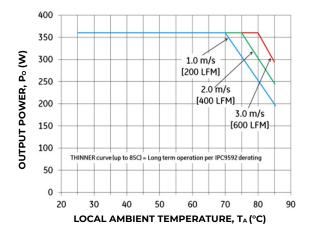


Figure 17. Output Power Derating for the QBVK037A5S9R6-H Base Plate Option in the Transverse Orientation; Airflow Direction from  $V_{\rm in}(-)$  to  $V_{\rm in}(+)$ ;  $V_{\rm in}$  = 55V.

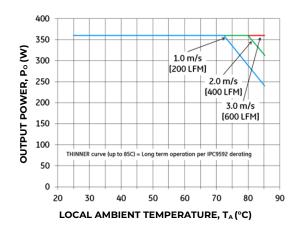


Figure 18. Output Power Derating for the QBVK037A5S9R6-H Base Plate Option in the Longitudinal Orientation; Airflow Direction from V<sub>out</sub> to V<sub>in</sub>; V<sub>in</sub> = 38 to 42V.

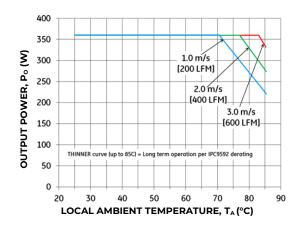


Figure 19. Output Power Derating for the QBVK037A5S9R6-H Base Plate Option in the Longitudinal Orientation; Airflow Direction from Vout to Vin; Vin = 50V.

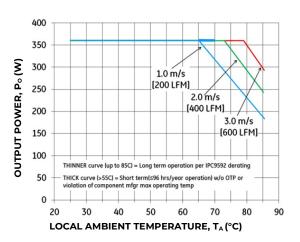


Figure 20. Output Power Derating for the QBVK037A5S9R6-H Base Plate Option in the Longitudinal Orientation; Airflow Direction from Vout to Vin; Vin = 55V.



# Thermal Considerations (continued) Layout Considerations

The QBVK037A5S9R6 power module series are low profile in order to be used in fine pitch system card architectures. As such, component clearance between the bottom of the power module and the mounting board is limited. Avoid placing copper areas on the outer layer directly underneath the power module. Also avoid placing via interconnects underneath the power module.

For additional layout guide-lines, refer to FLT012A0Z Data Sheet.

### Through-Hole Lead-Free Soldering Information

The RoHS-compliant, Z version, through-hole products use the SAC (Sn/Ag/Cu) Pb-free solder and RoHS-compliant components. The module is designed to be processed through single or dual wave soldering machines. The pins have a RoHS- compliant, pure tin finish that is compatible with both Pb and Pb-free wave soldering processes. A maximum preheat rate of 3°C/s is suggested. The wave preheat process should be such that the temperature of the power module board is kept below 210°C. For Pb solder, the recommended pot temperature is 260°C, while the Pb-free solder pot is 270°C max.

### Reflow Lead-Free Soldering Information

The RoHS-compliant through-hole products can be processed with the following paste-through-hole Pb or Pb-free reflow process.

Max. sustain temperature: 251°C (J-STD-020C Table 4-2: Packaging Thickness>=2.5mm / Volume > 2000mm<sup>3</sup>).

Peak temperature over 251°C is not suggested due to the potential reliability risk of components under continuous high- temperature.

Min. sustain duration above 217°C : 90 seconds Min. sustain duration above 180°C : 150 seconds

Max. heat up rate: 3°C/sec Max. cool down rate: 4°C/sec

In compliance with JEDEC J-STD-020C spec for 2 times reflow requirement.

### **Pb-free Reflow Profile**

BMP module will comply with J-STD-020 Rev. D (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb- free solder profiles and MSL classification procedures. BMP will comply with JEDEC J-STD-020C specification for 3 times reflow requirement. The suggested Pb-free solder paste is Sn/Ag/Cu (SAC). The recommended linear reflow profile using Sn/Ag/Cu solder is shown in Figure 21.

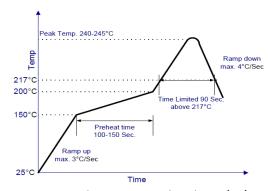


Figure 21. Recommended linear reflow profile using Sn/Ag/Cu solder.

### MSL Rating

The QBVK037A5S9R6 modules have a MSL rating as indicated in the Device Codes table, last page of this document.

### Storage and Handling

The recommended storage environment and handling procedures for moisture-sensitive surface mount packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/ Reflow Sensitive Surface Mount Devices). Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of ≤30°C and 60% relative humidity varies according to the MSL rating (see J-STD-060A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: < 40° C, < 90% relative humidity.

### **Post Solder Cleaning and Drying Considerations**

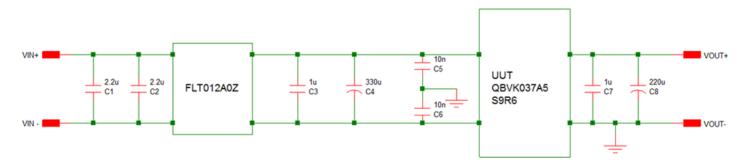
Post solder cleaning is usually the final circuit board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to OmniOn Board Mounted Power Modules: Soldering and Cleaning Application Note(AN04-001).

If additional information is needed, please consult with your OmniOn Sales representative for more details



### **EMC Considerations**

The circuit and plots in Figure 22 shows a suggested configuration to meet the conducted emission limits of EN55032 Class A. For further information on designing for EMC compliance, please refer to the FLT012A0Z data sheet.



C1 & C2 = 2.2uF 100V 1210

C3 & C7 = 1uF 100v 1210

C4 = 330uF 100V Nichicon VR series

C5 & C6 = 0.01uF 1500V 1210

C8 = 220uF 35V Nichicon PL series

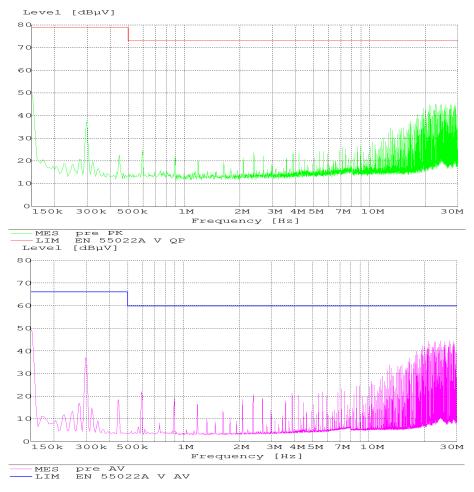


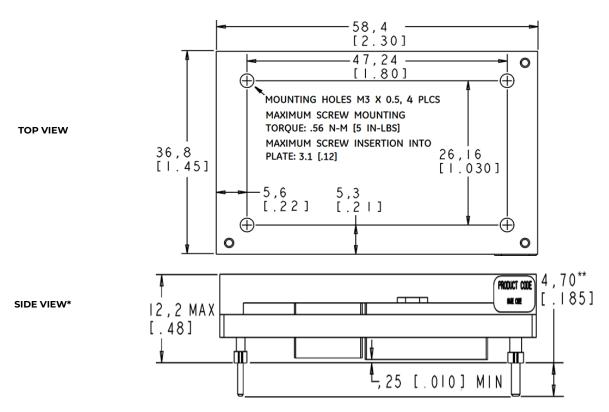
Figure 22. EMC Considerations



# Mechanical Outline for QBVK037A5S9R6-H (Base Plate) Through-hole Module

Dimensions are in millimeters and [inches].

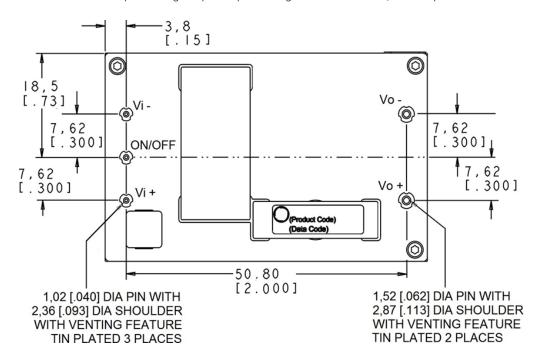
Tolerances: x.x mm  $\pm$ 0.5 mm [x.xx in.  $\pm$  0.02 in.] (Unless otherwise indicated) x.xx mm  $\pm$  0.25 mm [x.xxx in  $\pm$  0.010 in.]



\*Side label includes product designation, and data code

# BOTTOM VIEW\*\*\*

Pin Number	Pin Name
1	V <sub>IN</sub> (+)
2	ON/OFF
3	V <sub>IN</sub> (-)
4	V <sub>OUT</sub> (-)
8	V <sub>OUT</sub> (+)



 $\ensuremath{^{***}}\xspace$  Bottom side label includes OmniOn name, product designation, and data code

<sup>\*\*</sup> Standard pin tail length. Optional pin tail lengths shown in Table 2, Device Options.



# **Recommended Pad Layouts**

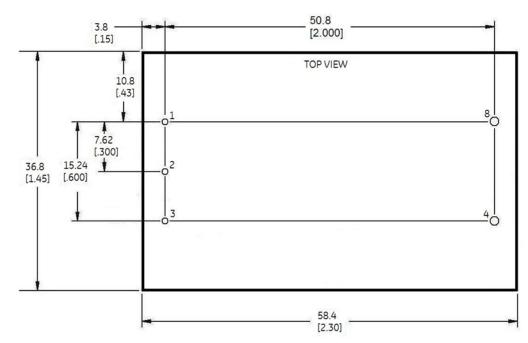
Dimensions are in millimeters and (inches).

Tolerances: x.x mm ± 0.5 mm [x.xx in. ± 0.02 in.] (unless otherwise indicated)

x.xx mm ± 0.25 mm [x.xxx in ± 0.010 in.]

# **Through-Hole Modules**

Pin Number	Pin Name
1	V <sub>IN</sub> (+)
2	ON/OFF
3	V <sub>IN</sub> (-)
4	V <sub>оит</sub> (-)
8	V <sub>OUT</sub> (+)



### Hole and Pad diameter recommendations:

Pin Number	Hole Dia (mm)	Pad Dia (mm)
1, 2, 3	1.6	2.1
4, 8	2.2	3.2



# **Packaging Details**

All versions of the QBVK037A5S9R6 are supplied as standard in the plastic trays shown in Figure 23.

# **Tray Specification**

Material PET (1mm) Max surface resistivity  $10^9 - 10^{11}\Omega/PET$ 

Color Clear

Capacity 12 power modules

Standard packing quantity 24 pcs (1 box of 2 full trays + 1 empty top tray)

Each tray contains a total of 12 power modules. The trays are self-stacking and each shipping box for the QBVK037A5S9R6 module contains 2 full trays plus one empty hold-down tray giving a total number of 24 power modules.

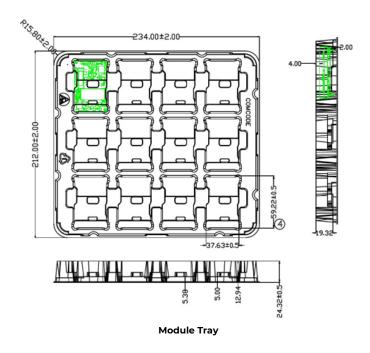


Figure 23. QBVK037A5S9R6 Packaging Tray



# **Ordering Information**

Please contact your OmniOn Sales Representative for pricing, availability and optional features.

Product codes	Input Voltage		Output Current	Efficiency	Connector Type	MSL Rating	Ordering Code
QBVK037A5S9R6641-PHZ	42/50V (38-55V <sub>dc</sub> )	9.6V	37.5A	95.8%	Through hole	2a	150033679

Table 1. Device Codes.

	Characteristic		Ch	naracter	and Po	si	tio	n					Definition
	Form Factor	Q										(	Q=Quarter Brick
	Family Designator		3									ŀ	BV=BARRACUDA Series, without PMBus interface
Ratings	Input Voltage		I	<									K=Modern Telecom Range, 50V (38V-55V)
	Output Power			037A5								(	037A5 =037.5 Amps Maximum Output Current
	Output Voltage				S9R6								S9R6=9.6V nominal
	Pin Length					6						ı	Omit = Default Pin Length shown in Mechanical Outline Figures 6 = Pin Length: 3.68 mm ± 0.25mm, (0.145 in. ± 0.010 in.)
	Action following Protective Shutdown						4						4 = Auto-restart following shutdown (Overcurrent/ Overvoltage)
Options	On/Off Logic							1					1 = Negative Logic
									-				
	Features								F	>  -	-1		P=Forced Droop Output for use in parallel application (must be ordered) H = Heat plate, for use with heat sinks or cold-walls (must be ordered)
	RoHS											Z	Z=RoHS Compliant

**Table 2. Device Options.** 

### **Contact Us**

For more information, call us at

- +1-877-546-3243 (US)
- +1-972-244-9288 (Int'l)



# **Change History (excludes grammar & clarifications)**

Revision	Date	Description of the change
1.4	06/21/2022	Updated as per template, ROHS
1.5	11/22/2023	Updated as per OmniOn template



### **OmniOn Power Inc.**

601 Shiloh Rd. Plano, TX USA

### omnionpower.com

We reserve the right to make technical changes or modify the contents of this document without prior notice. OmniOn Power does not accept any responsibility for errors or lack of information in this document and makes no warranty with respect to and assumes no liability as a result of any use of information in this document.

We reserve all rights in this document and in the subject matter and illustrations contained therein. Any reproduction, disclosure to third parties or utilization of its contents – in whole or in parts – is forbidden without prior written consent of OmniOn Power. This document does not convey license to any patent or any intellectual property right. Copyright© 2023 OmniOn Power Inc. All rights reserved.